

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6163150

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the ASSIGNEE NAME FROM STMICROELECTRONICS N.V. TO STMICROELECTRONICS INTERNATIONAL N.V. previously recorded on Reel 052303 Frame 0686. Assignor(s) hereby confirms the TRANSFERENCE FROM STMICROELECTRONICS S.R.L. TO STMICROELECTRONICS INTERNATIONAL N.V..	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	STMICROELECTRONICS S.R.L.	03/13/2020
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	STMICROELECTRONICS INTERNATIONAL N.V.	
<b>Street Address:</b>	CHEMIN DU CHAMP-DES-FILLES 39	
<b>Internal Address:</b>	PLAN-LES-OUATES	
<b>City:</b>	GENEVA	
<b>State/Country:</b>	SWITZERLAND	
<b>Postal Code:</b>	1228	
<b>PROPERTY NUMBERS Total: 2</b>		
	<b>Property Type</b>	<b>Number</b>
	Application Number:	62787026
	Application Number:	16726070
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>	(206)682-6031	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
<b>Phone:</b>	2066224900	
<b>Email:</b>	stephenm@seedip.com	
<b>Correspondent Name:</b>	SEED IP LAW GROUP	
<b>Address Line 1:</b>	701 5TH AVE	
<b>Address Line 2:</b>	SUITE 5400	
<b>Address Line 4:</b>	SEATTLE, WASHINGTON 98104	
<b>ATTORNEY DOCKET NUMBER:</b>	18TPYCO0143US02817063.447	
<b>NAME OF SUBMITTER:</b>	DAVID C. CONLEE	
<b>SIGNATURE:</b>	/David C. Conlee/	
<b>DATE SIGNED:</b>	06/19/2020	

**Total Attachments: 6**

source=07. Notice of Recordation Srl to NV - 20200406#page1.tif

source=07. Notice of Recordation Srl to NV - 20200406#page2.tif

source=07. Notice of Recordation Srl to NV - 20200406#page3.tif

source=07. Notice of Recordation Srl to NV - 20200406#page4.tif

source=07. Notice of Recordation Srl to NV - 20200406#page5.tif

source=07. Notice of Recordation Srl to NV - 20200406#page6.tif

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
STMICROELECTRONICS S.R.L.	03/13/2020
RECEIVING PARTY DATA	
Name:	STMICROELECTRONICS N.V. STMICROELECTRONICS INTERNATIONAL N.V.
Street Address:	CHEMIN DU CHAMP-DES-FILLES 39
Internal Address:	PLAN-LES-OUATES
City:	GENEVA
State/Country:	SWITZERLAND
Postal Code:	1228
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	62787026
Application Number:	16726070
CORRESPONDENCE DATA	
Fax Number:	(206)682-6031
Phone:	2066224900
Email:	stephenm@seedip.com
Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.	
Correspondent Name:	SEED IP LAW GROUP
Address Line 1:	701 5TH AVE
Address Line 2:	SUITE 5400
Address Line 4:	SEATTLE, WASHINGTON 98104
ATTORNEY DOCKET NUMBER:	18TPYCO0143US02817063.447
NAME OF SUBMITTER:	DAVID C. CONLEE
Signature:	/David C. Conlee/
Date:	04/03/2020

**Total Attachments: 2**

source=62787026 16726070 SRL to NV#page1.tif  
source=62787026 16726070 SRL to NV#page2.tif

**RECEIPT INFORMATION**

**EPAS ID:** PAT6045463  
**Receipt Date:** 04/03/2020

## ASSIGNMENT

Application Numbers: *62/787,026 and 16/726,070*

Filing Dates: *December 31, 2018 and December 23, 2019*

Application Country/Region: *United States*

Application Title: *LEADFRAME WITH A METAL OXIDE COATING AND METHOD OF FORMING THE SAME*

Assignee: *STMicroelectronics International N.V.*

Assignee being a company, corporation, or juristic entity of: *Netherlands*

Assignee's principal place of business: *Chemin du Champ-des-Filles 39, Plan-les-Ouates, Geneva, Switzerland 1228*

WHEREAS, Assignor, *STMicroelectronics S.r.l.*, a corporation of Italy, was assigned certain rights in and to certain inventions, and application for Letters Patent of the United States entitled *LEADFRAME WITH A METAL OXIDE COATING AND METHOD OF FORMING THE SAME*, assigned U.S. Application Nos. *62/787,026* filed *December 31, 2018*, and *16/726,070* filed *December 23, 2019*; and

WHEREAS, Assignee, *STMicroelectronics International N.V.*, a corporation of the Netherlands, residing or having a principal place of business at *Chemin du Champ-des-Filles 39, Plan-les-Ouates, Geneva, Switzerland 1228*, is desirous of acquiring the entire right, title and interest in and to the inventions and the application for Letters Patent of the United States, and in and to any Letters Patent to be obtained therefor and thereon worldwide.

Now, therefore, for and in consideration of good and valuable consideration, the receipt, sufficiency, and adequacy of which are hereby acknowledged, Assignor hereby transfers and assigns to Assignee, its legal representatives, successors, and assigns, its entire right, title, and interest in and to the inventions for which the above identified patent application is made and describes (hereinafter referred to as "the Patent Rights"), together with any and all patents or patent applications anywhere worldwide to which any of the Patent Rights directly or indirectly claims priority, including but not limited to provisional applications thereof, or for which any of the Patent Rights directly or indirectly forms a basis for priority, together with all existing and/or future continuations, continuations-in-part, continuing prosecution applications, requests for continuing examinations, divisions, reissues, reexaminations, extensions, registrations, and foreign counterparts of any item in any of the foregoing, together with the right to sue for and be entitled to any damages, injunctive relief, and any other remedies of any kind for past, current, and future infringement thereof, together with all rights worldwide in the Patent Rights; said entire right, title, and interest, to be held and enjoyed by the Assignee for its own use and enjoyment and for the use and enjoyment of its legal representatives, successors, and assigns to the full end of the term for which the aforementioned rights may be granted anywhere in the world.

Assignor hereby further agrees to assist in and execute all documents needed now or in the future to perfect, obtain, and secure the aforementioned rights to Assignee, its legal representatives, successors, and assigns, for any jurisdiction in the world. At the expense of Assignee, or its legal representatives, successors, or assigns, Assignor agrees to assist in any legal

ST Docket Number: *18-TPYCO-0143US02* 1

proceedings, sign all lawful papers, make all lawful oaths, and generally do everything possible to aid Assignee, its legal representatives, successors, and assigns, to enforce the aforementioned rights in any and all countries and regions worldwide.

Assignor hereby grants Assignee, along with the following Assignee representatives, the power to insert in this Assignment any further identification that may be necessary or desirable in order to comply with the rules for recordation of this document any place in the world: All practitioners at Customer Number **30423**.

For: *STMicroelectronics S.r.l*

Date: March 13<sup>th</sup> 2020 Signature: Lucio Colombo (Assignor)

Print Name: Lucio Colombo

Title: General Manager

For: *STMicroelectronics International N.V.*

Acknowledged and accepted by:

Date: March 23, 2020 Signature: [Signature] (Assignee)

Print Name: Steven Rose

Title: President, Legal Counsel

Seed Ref. No. 817063.447 | 7243611\_1.DOC

ST Docket Number: **18-TPYCO-0143US02** 2